

### 60V N-Channel Enhancement Mode MOSFET

TO-220F

#### Description

The APG130N06P/T/F uses advanced APM-SGT I technology

to provide excellent R<sub>DS(ON)</sub>, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a Battery protection

or in other Switching application.

#### **General Features**

V<sub>DS</sub> = 60V I<sub>D</sub> =130A

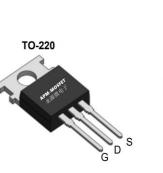
 $R_{DS(ON)} < 3.5m\Omega @ V_{GS}=10V$  (Type: 2.8m $\Omega$ )

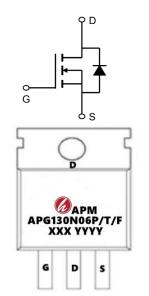
### Application

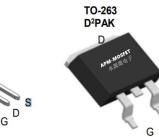
Battery protection

Load switch

Uninterruptible power supply







Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
APG130N06P	TO-220-3L	APG130N06P XXX YYYY	1000
APG130N06T	TO-263-3L	APG130N06T XXX YYYY	800
APG130N06F	TO-220F-3L	APG130N06F XXX YYYY	1000

#### Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	60	V
VGS	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current <sup>1,6</sup>	130	А
I₀@Tc=100°C	Continuous Drain Current <sup>1,6</sup>	66	А
IDM	Pulsed Drain Current <sup>2</sup> 240		А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	101	mJ
IAS	Avalanche Current	130	А
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation <sup>4</sup>	Dissipation <sup>4</sup> 168	
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	Dperating Junction Temperature Range -55 to 150	
R₀JA	Thermal Resistance Junction-Ambient <sup>1</sup>	60	°C/W
R₀JC	Thermal Resistance Junction-Case <sup>1</sup>	1.5	°C/W



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### Electrical Characteristics (TJ=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Мах	Units	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage V <sub>GS</sub> = 0V, I <sub>D</sub> =250		60	67		V	
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V			1	μA	
IGSS	Gate-Body Leakage Current	V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0V			±100	nA	
VGS(th)	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250µA	1.2	1.8	2.5	V	
		V <sub>GS</sub> = 10V, I <sub>D</sub> =20A		2.8	3.5		
RDS(ON)	Static Drain-Source On-Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> =15A		3.2	4.0	mΩ	
Ciss	Input Capacitance			5950			
Coss	Output Capacitance V <sub>DS</sub> =25V,V <sub>GS</sub> =0V,f=100KHZ			1250		pF	
Crss	Reverse Transfer Capacitance			85			
Qg	Total Gate Charge			93			
Qgs	Gate-Source Charge	Gate-Source Charge V <sub>GS</sub> =10V,V <sub>DS</sub> =50V,I <sub>D</sub> =50A		17		nC	
$Q_{gd}$	Gate-Drain Charge			14			
Qrr	Reverse Recovery Chrage	e I <sub>F</sub> =25A, di/dt=100A/us		73			
trr	Reverse Recovery Time	1 = 25 , $1 = 100$		68			
td(on)	Turn-on Delay Time			22.5		ns	
tr	Turn-on Rise Time V <sub>GS</sub> =10V,V <sub>DD</sub> =30V,I <sub>D</sub> =25A			6.7			
td(off)	Turn-off Delay Time	R <sub>GEN</sub> =2Ω		80.3			
t <sub>f</sub>	Turn-off fall Time			26.9			
Vsd	Diode Forward Voltage				1.2	V	
ls	Maximum Body-Diode Continuous Current	Is=20A,V <sub>GS</sub> =0V			200	А	

Note :

1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.

2、 The data tested by pulsed , pulse width  $\leq 300 \text{us}$  , duty cycle  $\leq 2\%$ 

3、 The EAS data shows Max. rating . The test condition is VDD=48V,VGS=10V, L=0.1mH IAS=130A

4、 The power dissipation is limited by 150°C junction temperature

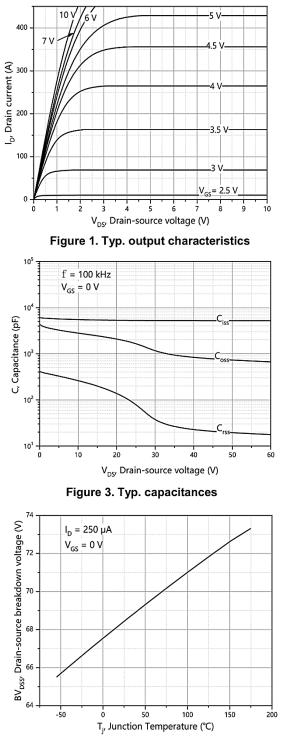
5. The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation

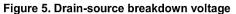
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### **Typical Characteristics**





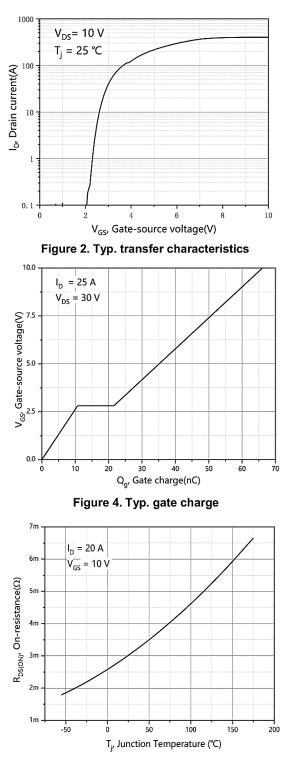


Figure 6. Drain-source on-state resistance



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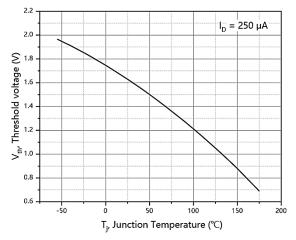


Figure 7. Threshold voltage

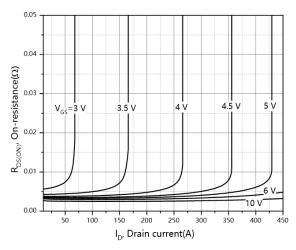


Figure 9. Drain-source on-state resistance

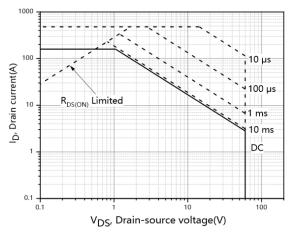


Figure 11. Safe operation area T<sub>C</sub>=25 °C

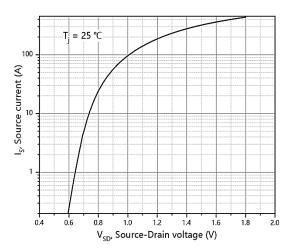


Figure 8. Forward characteristic of body diode

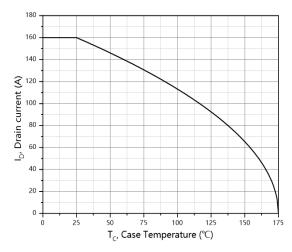


Figure 10. Drain current

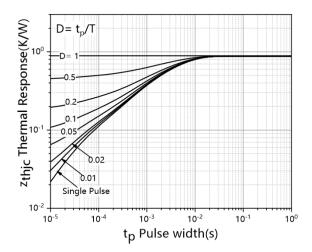


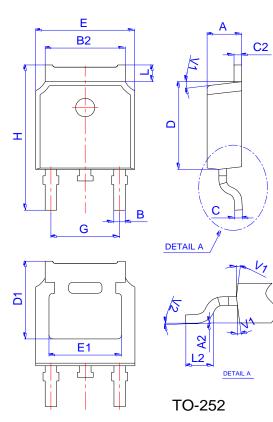
Figure 12. Max. transient thermal impedance

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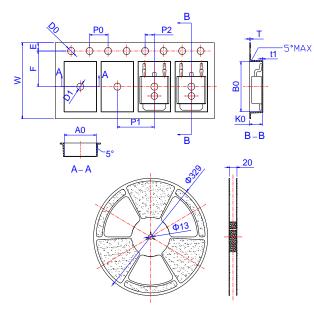
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## Package Mechanical Data



	Dimensions						
Ref.	Millimeters		'S	Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
A	2.10		2.50	0.083		0.098	
A2	0		0.10	0		0.004	
В	0.66		0.86	0.026		0.034	
B2	5.18		5.48	0.202		0.216	
С	0.40		0.60	0.016		0.024	
C2	0.44		0.58	0.017		0.023	
D	5.90		6.30	0.232		0.248	
D1		5.30REF		0.209REF			
E	6.40		6.80	0.252		0.268	
E1	4.63			0.182			
G	4.47		4.67	0.176		0.184	
Н	9.50		10.70	0.374		0.421	
L	1.09		1.21	0.043		0.048	
L2	1.35		1.65	0.053		0.065	
V1		7°			7°		
V2	0°		6°	0°		6°	

## **Reel Spectification-TO-252**



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
Е	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
Т	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583

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## 60V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.1	2018/1/31	Initial release
Rve1.2	2021/8/23	Reduce RDS(on)

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